

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4235804

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SEO YOUNG KIM	01/09/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HYLIUM INDUSTRIES, INC.
<b>Street Address:</b>	#401 (SANGAM-DONG, DMC HI-TECH INDUSTRY CENTER) 37
<b>Internal Address:</b>	MAEBONGSAN-RO, MAPO-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	03909
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15404114
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(215)557-8477
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	215-557-6656
<b>Email:</b>	juli@mendelip.com
<b>Correspondent Name:</b>	KEVIN J. DUNLEAVY
<b>Address Line 1:</b>	1500 JOHN F. KENNEDY BLVD.
<b>Address Line 2:</b>	SUITE 312
<b>Address Line 4:</b>	PHILADELPHIA, PENNSYLVANIA 19102
<b>ATTORNEY DOCKET NUMBER:</b>	JSIP-1024US
<b>NAME OF SUBMITTER:</b>	KEVIN J. DUNLEAVY
<b>SIGNATURE:</b>	/Kevin J. Dunleavy/
<b>DATE SIGNED:</b>	01/20/2017
<b>Total Attachments: 2</b>	
source=Assignment#page1.tif	
source=Assignment#page2.tif	

**ASSIGNMENT**

WHEREAS, **Seo Young Kim**, residing at #104-1202 (Daechi-dong, Posco the sharp Apt.) 417, Samseong-ro, Gangnam-gu, Seoul 06195, Republic of Korea (hereinafter referred to as, “the Assignor”) is the inventor of certain invention(s) or improvement(s) as described and/or claimed in Korean Patent Application Nos. 10-2016-0007292, filed January 20, 2016 and 10-2016-0034870, filed March 23, 2016, entitled, “SMALL-SCALE HYDROGEN LIQUEFACTION SYSTEM EQUIPPED WITH CRYOCOOLER”, for which I will make application(s) for Letters Patent to the United States of America (“United States”), entitled, “SMALL-SCALE HYDROGEN LIQUEFACTION SYSTEM EQUIPPED WITH CRYOCOOLER,” and for which I filed U.S. Patent Application No. 15/404,114 on January 11, 2017, having a docket number JSIP-1024US. If not already inserted, I hereby authorize and request the law firm of Mendelsohn Dunleavy, PC, of 1500 John F. Kennedy Blvd., Suite 312, Philadelphia, PA 19102, to insert herein the filing date(s) and application number(s) of said application(s) when known.

WHEREAS, **HYLIUM INDUSTRIES, INC.**, having its principal place of business at #401 (Sangam-dong, DMC Hi-Tech Industry Center) 37, Maebongsan-ro, Mapo-gu, Seoul 03909, Republic of Korea, hereinafter referred to as the Assignee, is desirous of acquiring the entire right, title and interest in and to the said Patent Property in any and all countries;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) to me in hand paid by said Assignee, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said Assignor, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over to said Assignee, the entire right, title and interest in and to said invention(s) or improvement(s) and said application(s) including the right to claim priority to the application(s) in any application entitled to claim such priority under national law, international conventions, treaties or otherwise, and any and all continuations, divisions and renewals of and substitutes for said application(s), and in, to and under any and all Letters Patent which may be granted on or as a result thereof in the United States and any and all other countries, and any reissue or reissues or extension or extensions of said Letters Patent, and assign to and authorize said Assignee, to file in our name applications for Letters Patent in all countries, the same to be held and enjoyed by said Assignee, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me had this assignment, sale and transfer not been made.

AND I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith, and I further covenant and agree that I will each time a request is made and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said inventions or improvements, said application and said Letters Patent to said assignee, its successors, assigns, nominees, or legal representatives, and I agree to communicate to said assignee or to its nominee all known facts respecting said inventions or improvements, said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisional, continuing and reissue applications, to make all rightful oaths, and generally to do everything possible to aid said assignee, its successors, assigns, nominees and legal representatives to obtain and enforce for its or their own benefit proper patent protection for said inventions or improvements in the United States.

AND I hereby authorize and request the Director of Patents and Trademarks of the United States to issue to said assignee, as assignee of the entire right, title and interest, any and all Letters Patent for said inventions or improvements, including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

This assignment shall be governed by the laws of the State of Pennsylvania, United States of America.

IN WITNESS WHEREOF, I have hereunto set my hand and seal.

Dated:

01/09/17

Seo Young Kim (L.S.)  
Seo Young Kim